# SPECIFICATIONS FOR NICHIA BLUISH-GREEN LED

MODEL: NSPE310S

NICHIA CORPORATION

# 1.SPECIFICATIONS

# (1) Absolute Maximum Ratings

 $(Ta=25^{\circ}C)$ 

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	35	mA
Pulse Forward Current	IFP	110	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	120	mW
Operating Temperature	Topr	<b>-</b> 30 ∼ + 85	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Soldering Temperature	Tsld	265°C for 10sec.	

IFP Conditions : Pulse Width  $\leq 10$ msec. and Duty  $\leq 1/10$ 

# (2) Initial Electrical/Optical Characteristics

 $(Ta=25^{\circ}C)$ 

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Item		Symbol	Condition	Тур.	Max.	Unit
Forward Voltage		VF	I <sub>F</sub> =10[mA]	(3.1)	3.45	V
Reverse Current		Ir	$V_R = 5[V]$	-	50	μΑ
Luminous Intensity		Iv	I <sub>F</sub> =10[mA]	(5.5)	-	cd
Characticites Consulingto	X	-	I <sub>F</sub> =10[mA]	0.085	-	-
Chromaticity Coordinate	у	-	I <sub>F</sub> =10[mA]	0.490	-	-

- \* Forward Voltage Measurement allowance is  $\pm 0.05$ V.
- \* Luminous intensity value is traceable to the CIE 127:2007-compliant national standards.
- ★ Please refer to CIE 1931 chromaticity diagram.

(3) Ranking

 $(Ta=25^{\circ}C)$ 

Item		Symbol	Condition	Min.	Max.	Unit
	Rank W			6.4	9.2	
Luminous Intensity	Rank V	Iv	I <sub>F</sub> =10[mA]	4.6	6.4	cd
	Rank U			3.2	4.6	

<sup>\*</sup> Luminous Intensity Measurement allowance is  $\pm$  10%.

Color Ranks

 $(IF=10mA, Ta=25^{\circ}C)$ 

0.13

0.48

0.13

0.58

Rank D

0.05

0.58

0.05

0.48

	Rank C					
X	0.04	0.04	0.12	0.12		
у	0.39	0.49	0.49	0.39		

	Rank E					
X	0.06	0.06	0.14	0.14		
y	0.55	0.65	0.65	0.55		

- \* Color Coordinates Measurement allowance is  $\pm 0.012$ .
- \* Basically, a shipment shall consist of the LEDs of a combination of the above ranks.

The percentage of each rank in the shipment shall be determined by Nichia.

Correspondence table of Color Coordinates – Luminous Intensity ranks

Ranking by Luminous Intensity Ranking by Color Coordinates	U	V	W
C, D			
Е			

<sup>\*</sup> Shaded ranks are available.

#### 2.INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to "CHARACTERISTICS" on the following pages.

#### 3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to "OUTLINE DIMENSIONS" on the following page.

#### 4.PACKAGING

· The LEDs are packed in cardboard boxes after packaging in anti-electrostatic bags.

Please refer to "PACKING" on the following pages.

The label on the minimum packing unit shows; Part Number, Lot Number, Ranking, Quantity

- · In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
- The LEDs may be damaged if the boxes are dropped or receive a strong impact against them, so precautions must be taken to prevent any damage.
- · The boxes are not water resistant and therefore must be kept away from water and moisture.
- · When the LEDs are transported, we recommend that you use the same packing method as Nichia.

### 5.LOT NUMBER

The first six digits number shows **lot number**.

The lot number is composed of the following characters;

# **6.RELIABILITY**

# (1) TEST ITEMS AND RESULTS

	Standard			Number of
Test Item	Test Method	Test Conditions	Note	Damaged
Resistance to JEITA ED-4701		Tsld= $260 \pm 5$ °C, $10$ sec.	1 time	0/50
Soldering Heat	300 302	3mm from the base of the epoxy bulb		
Temperature Cycle	JEITA ED-4701	-40°C ~ 25°C ~ 100°C ~ 25°C	100 cycles	0/50
	100 105	30min. 5min. 30min. 5min.		
Moisture Resistance Cyclic	JEITA ED-4701	25°C ~ 65°C ~ -10°C	10 cycles	0/50
	200 203	90%RH 24hrs./1cycle		
Terminal Strength	JEITA ED-4701	Load 5N (0.5kgf)	No noticeable	0/50
(bending test)	400 401	$0^{\circ} \sim 90^{\circ} \sim 0^{\circ}$ bend 2 times	damage	
Terminal Strength	JEITA ED-4701	Load 10N (1kgf)	No noticeable	0/50
(pull test)	400 401	$10 \pm 1$ sec.	damage	
High Temperature Storage	JEITA ED-4701	Ta=100°C	1000hrs.	0/50
	200 201			
Temperature Humidity	JEITA ED-4701	Ta=60°C, RH=90%	1000hrs.	0/50
Storage	100 103			
Low Temperature Storage	JEITA ED-4701	Ta=-40°C	1000hrs.	0/50
	200 202			
Steady State Operating Life		Ta=25°C, IF=35mA	1000hrs.	0/50
Steady State Operating Life		60°C, RH=90%, IF=20mA	500hrs.	0/50
of High Humidity Heat				
Steady State Operating Life		Ta=-30°C, IF=20mA	1000hrs.	0/50
of Low Temperature				

# (2) CRITERIA FOR JUDGING DAMAGE

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			Criteria for Judgement			
Item	Symbol	Test Conditions	Min.	Max.		
Forward Voltage	VF	I <sub>F</sub> =10mA	-	U.S.L.*)× 1.1		
Reverse Current	IR	V <sub>R</sub> =5V	-	U.S.L.*)× 2.0		
Luminous Intensity	Iv	I <sub>F</sub> =10mA	L.S.L.**)× 0.7	-		

#### 7.CAUTIONS

#### (1) Lead Forming

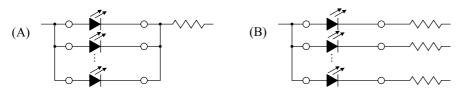
- · When forming leads, the leads should be bent at a point at least 3mm from the base of the epoxy bulb. Do not use the base of the leadframe as a fulcrum during lead forming.
- · Lead forming should be done before soldering.
- · Do not apply any bending stress to the base of the lead. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- · When mounting the LEDs onto a printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LEDs. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

#### (2) Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Nichia and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- The lead part may be affected by environments which contain corrosive substances. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- · Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

## (3) Recommended circuit

· In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LEDs with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage (V<sub>F</sub>) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

# (4) Static Electricity

- · Static electricity or surge voltage damages the LEDs.

  It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- · All devices, equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.
- · When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- · Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

Criteria: (VF > 2.0V at IF=0.5mA)

# (5) Soldering Conditions

· Solder the LED no closer than 3mm from the base of the epoxy bulb. Soldering beyond the base of the tie bar is recommended.

· Recommended soldering conditions

Dip Soldering		Hand Soldering		
Pre-Heat	120°C Max.	Temperature	350°C Max.	
Pre-Heat Time	60 seconds Max.	Soldering Time	3 seconds Max.	
Solder Bath	260°C Max.	Position	No closer than 3 mm from the	
Temperature			base of the epoxy bulb.	
Dipping Time	10 seconds Max.			
Dipping Position	No lower than 3 mm from the			
	base of the epoxy bulb.			

- · Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LEDs.
- · A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- · Dip soldering should not be done more than one time.
- · Hand soldering should not be done more than one time.
- · Do not apply any stress to the lead particularly when heated.
- · The LEDs must not be repositioned after soldering.
- · After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- · Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused from warping of the PC board or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion but the customer will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. Nichia's LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.
- · When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- · Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.

#### (6) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

### (7) Cleaning

- It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
- · Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

#### (8) Safety Guideline for Human Eyes

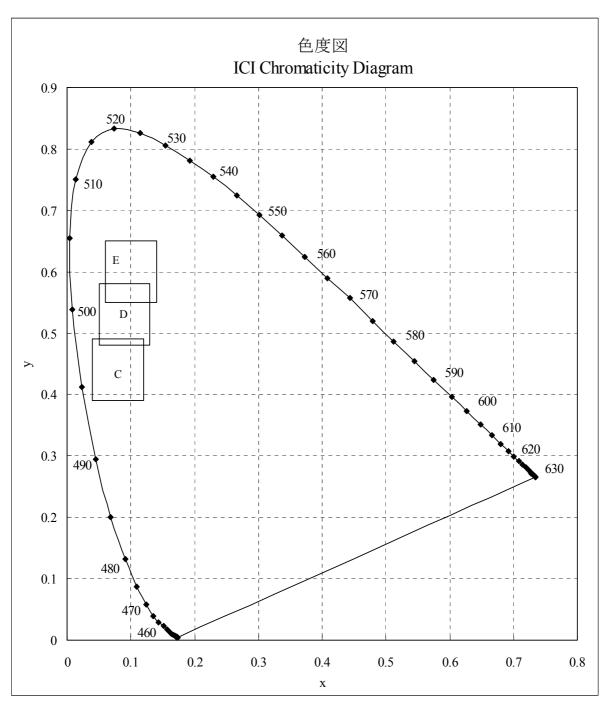
• The International Electrical Commission (IEC) published in 2006 IEC 62471:2006 Photobiological safety of lamps and lamp systems which includes LEDs within its scope. Meanwhile LEDs were removed from the scope of the IEC 60825-1:2007 laser safety standard, the 2001 edition of which included LED sources within its scope. However, keep in mind that some countries and regions have adopted standards based on the IEC laser safety standard IEC 60825-1:2001 which includes LEDs within its scope.

Following IEC 62471:2006, most of Nichia LEDs can be classified as belonging to either Exempt Group or Risk Group 1. Optical characteristics of a LED such as radiant flux, spectrum and light distribution are factors that affect the risk group determination of the LED. Especially a high-power LED, that emits light containing blue wavelengths, may be in Risk Group 2.

Great care should be taken when viewing directly the LED driven at high current or the LED with optical instruments, which may greatly increase the hazard to your eyes.

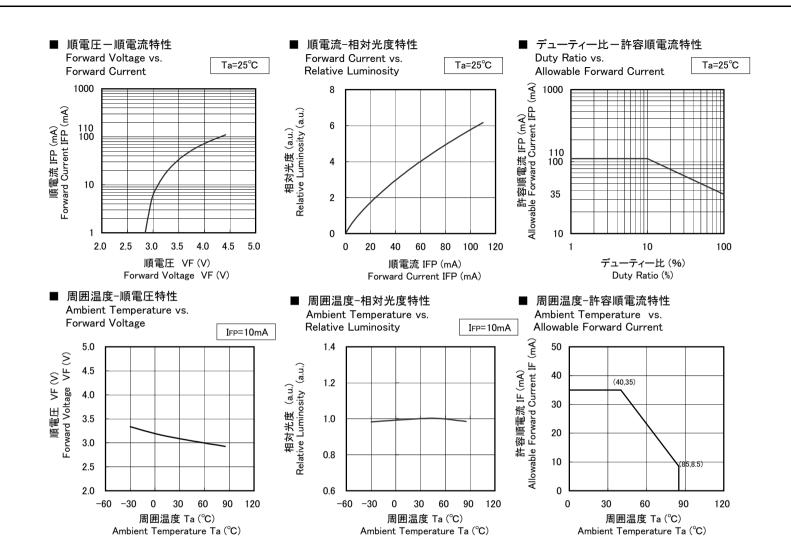
#### (9) Others

- · NSPE310S complies with RoHS Directive.
- · If the LEDs are being used after being fixed into a case (container, box, etc...) the LEDs must not be mounted so that the epoxy lens is pressed or glued onto a plastic (or metal) board.
- · Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- These LEDs are designed and manufactured for standard applications of traffic signals. It is recommended to consult with Nichia in advance if these LEDs are used for other applications.
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the customer shall inform Nichia directly before disassembling or analysis.
- · The formal specifications must be exchanged and signed by both parties before large volume purchase begins.
- The appearance and specifications of the product may be modified for improvement without notice.



\* Color Coordinates Measurement allowance is  $\pm$  0.012.

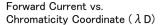




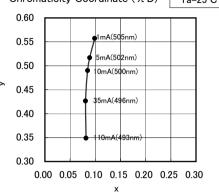
型名 Model NSPE310(S)	名称 Title	初期電気/光学特性 CHARACTERISTICS
日亜化学工業(株) NICHIA CORPORATION	管理番- No.	月 100309 057071

Nichia STS-DA1-1102 <Cat.No.100331>

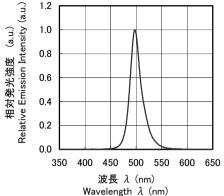
■ 順電流-色度(主波長)特性



Ta=25°C

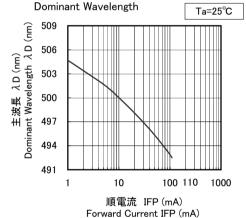


■ 発光スペクトル Spectrum Ta=25°C IF= 10mA



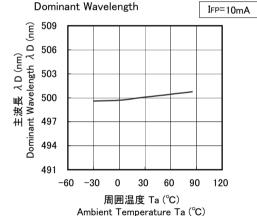
■ 順電流-主波長特性

Forward Current vs.



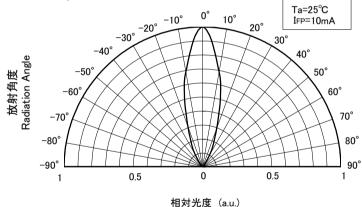


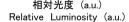
Ambient Temperature vs.



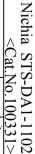
## ■ 指向特性

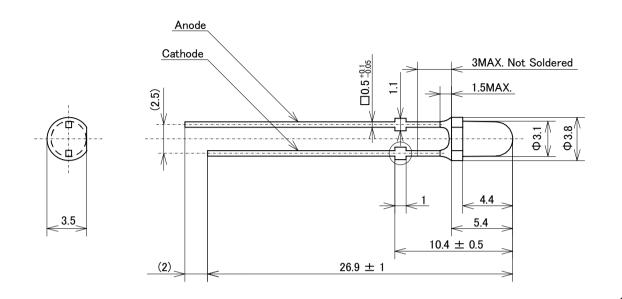
Directivity





型名 Model NSPE310(S)	A称 初期電気/光学特性 Title CHARACTERISTICS
日亜化学工業(株)	管理番号
NICHIA CORPORATION	No. 100309057081





項目 Item	材質 Materials
樹脂	エポキシ樹脂
Resin	Epoxy Resin
リードフレーム	鉄+銀メッキ+鉛フリーはんだメッキ
Leadframe	Ag plating Iron Solder-dipped leads (Lead-free)

(注1) タイバーを切り取った部分は鉄が露出しております。 またLEDには鋭利な部分があります。特にリード部分は、人体を傷つける ことがありますので、取り扱いに際しては十分注意して下さい。

(NOTE1) Please note that the bare iron showing at the cut end of the lead frame may be corroded under certain conditions.

LEDs have some sharp edges and points, particularly lead frames.

Please handle with care so as to avoid injuries.

(注2) はんだメッキ部に素地の著しい露出はないこととします。

(NOTE2) No noticeable exposure of base coat for the leads with solder-dipped finishes.

	型名 Model	名称	外形寸法図	単位Unit	2
	NSPE310S	1	TLINE DIMENSIONS	mm	į
	日亜化学工業(株) NICHIA CORPORATION	管理番号 No.	STSZ-H057091	公差 Allow ±0.2	1001

0.3

ストッパー部詳細図 Detail of stopper

